

July 3, 2023
SoftBank Group Corp.

Early Redemption of Domestic Hybrid Bonds
(with a Subordination Provision) Issued in 2016

SoftBank Group Corp. announced today that it will redeem all of its 2nd unsecured subordinated bonds with interest deferrable clause and early redeemable option (with a subordination provision) on September 16, 2023, the first optional redemption date. The details of the redemption are as follows.

**2nd unsecured subordinated bonds with interest deferrable clause and early redeemable option
(with a subordination provision)**

1. Total amount of issue	JPY 15.4 billion
2. Date of issue	September 16, 2016
3. Maturity date	September 16, 2043
4. Date of early redemption	September 16, 2023 (first optional redemption date)
5. Interest rate	3.50% per annum
6. Total amount of early redemption	JPY 15.4 billion
7. Amount of early redemption	JPY 100 per each bond of JPY 100